

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NEHA DAWAR	07/14/2021
HOANG VIET NGUYEN	07/14/2021
YUMING ZHU	07/14/2021
BOON LOONG NG	07/14/2021
YI YANG	07/19/2021
MOONSEOK KANG	05/12/2023
ADITYA VINOD PADAKI	07/14/2021
SONGWEI LI	07/14/2021
MOONGEE CHO	07/28/2021
HYUNCHUL KIM	05/12/2023
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17443321
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NAME OF SUBMITTER:	JACOB L. LACOMBE
SIGNATURE:	/Jacob L. LaCombe/
DATE SIGNED:	05/12/2023
Total Attachments: 10 source=SAMS10-01768 ExecutedDeclarationAssignment#page1.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page2.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page3.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page4.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page5.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page6.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page7.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page8.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page9.tif source=SAMS10-01768 ExecutedDeclarationAssignment#page10.tif	

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET
(37 CFR 1.76) AND ASSIGNMENT**

Title of Invention	ANGLE OF ARRIVAL CAPABILITY IN ELECTRONIC DEVICES
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As the undersigned inventor, I hereby declare that:

This combined declaration and assignment is directed to: The attached application, or
 United States application or PCT International application number _____
 filed on _____.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application including the claims, for which this combined declaration and assignment is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do, 16677, Korea (hereinafter referred to as "ASSIGNEE"), desires to acquire the entire right, title and interest in said invention and to any patent that may be granted thereon in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration, the receipt whereof is hereby acknowledged, We, the below named inventors, hereby sell, assign and transfer to said ASSIGNEE, its successors and assigns, the entire right, title and interest in the above-identified application and the invention disclosed therein in all countries, including all divisional applications, continuation applications, and corresponding priority applications including those to which priority is claimed under the International Convention of Paris including under 35 U.S.C. 119, substitutions, and renewals thereof, and to all patents that may be granted thereon, and all reissues thereof.

We hereby authorize and request the Patent Office Officials in the United States and all foreign countries to issue patents, when granted, to said ASSIGNEE, its successors and assigns. Further, We agree that said ASSIGNEE, its successors and assigns, may apply for patents for the invention in foreign countries without further authorization from us. Also, We agree to execute all papers and generally to do everything possible to aid said ASSIGNEE, its successors and assigns, in obtaining and enforcing patents for the invention in all countries.

I hereby acknowledge that any willful false statement made in this combined declaration and assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF FIRST INVENTOR (e.g., full first name, middle initial, last name)

Inventor: Neha Dawar Date: Jul 14, 2021

Signature: / Neha Dawar

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Inventor: Hoang Viet Nguyen Date: Jul 14, 2021

Signature: */Hoang Viet Nguyen*

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Inventor: Yuming Zhu Date: Jul 14, 2021

Signature: *Yuming Zhu* /

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Inventor: Boon Loong Ng Date: Jul 14, 2021

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Inventor: Moonseok Kang Date: May 12, 2023

Signature: /  /

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Inventor: Aditya Vinod Padaki

Date: Jul 14, 2021

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Inventor: Moongee Cho

Date: Jul 28, 2021

Signature: *Moongee Cho* /

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Inventor: Hyunchul Kim Date: May 12, 2023

Signature: *Hyunchul Kim* /